



Welcome to [E-XFL.COM](https://www.e-xfl.com)

What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	AVR
Core Size	8-Bit
Speed	20MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	23
Program Memory Size	16KB (8K x 16)
Program Memory Type	FLASH
EEPROM Size	512 x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	32-TQFP
Supplier Device Package	32-TQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/atmel/atmega168pa-ccu

- Peripheral Features
 - Two 8-bit Timer/Counters with Separate Prescaler and Compare Mode
 - One 16-bit Timer/Counter with Separate Prescaler, Compare Mode, and Capture Mode
 - Real Time Counter with Separate Oscillator
 - Six PWM Channels
 - 8-channel 10-bit ADC in TQFP and QFN/MLF package
 - Temperature Measurement
 - 6-channel 10-bit ADC in PDIP Package
 - Temperature Measurement
 - Two Master/Slave SPI Serial Interface
 - One Programmable Serial USART
 - One Byte-oriented 2-wire Serial Interface (Philips I²C compatible)
 - Programmable Watchdog Timer with Separate On-chip Oscillator
 - One On-chip Analog Comparator
 - Interrupt and Wake-up on Pin Change
- Special Microcontroller Features
 - Power-on Reset and Programmable Brown-out Detection
 - Internal Calibrated Oscillator
 - External and Internal Interrupt Sources
 - Six Sleep Modes: Idle, ADC Noise Reduction, Power-save, Power-down, Standby, and Extended Standby
- I/O and Packages
 - 23 Programmable I/O Lines
 - 28-pin PDIP, 32-lead TQFP, 28-pad QFN/MLF and 32-pad QFN/MLF
- Operating Voltage:
 - 1.8 - 5.5V
- Temperature Range:
 - -40°C to 105°C
- Speed Grade:
 - 0 - 4MHz @ 1.8 - 5.5V
 - 0 - 10MHz @ 2.7 - 5.5V
 - 0 - 20MHz @ 4.5 - 5.5V
- Power Consumption at 1MHz, 1.8V, 25°C
 - Active Mode: 0.2mA
 - Power-down Mode: 0.1µA
 - Power-save Mode: 0.75µA (Including 32kHz RTC)

Table of Contents

Introduction.....	1
Feature.....	1
1. Description.....	4
2. Configuration Summary.....	5
3. Ordering Information	6
3.1. ATmega48PA.....	6
3.2. ATmega88PA	7
3.3. ATmega168PA.....	8
4. Block Diagram.....	9
5. Pin Configurations.....	10
5.1. Pin-out.....	10
5.2. Pin Descriptions.....	14
6. I/O Multiplexing.....	16
7. Resources.....	18
8. Data Retention.....	19
9. About Code Examples.....	20
10. Capacitive Touch Sensing.....	21
10.1. QTouch Library.....	21
11. Packaging Information.....	22
11.1. 32-pin 32A.....	22
11.2. 32-pin 32M1-A.....	23
11.3. 32-pin 32CC1.....	24
11.4. 28-pin 28M1.....	25
11.5. 28-pin 28P3.....	26

2. Configuration Summary

Features	ATmega48PA/88PA/168PA
Pin Count	28/32
Flash (Bytes)	4K/8K/16K
SRAM (Bytes)	512/1K/1K
EEPROM (Bytes)	256/512/512
Interrupt Vector Size (instruction word/vector)	1/1/2
General Purpose I/O Lines	23
SPI	2
TWI (I ² C)	1
USART	1
ADC	10-bit 15kSPS
ADC Channels	8
8-bit Timer/Counters	2
16-bit Timer/Counters	1

ATmega88PA and ATmega168PA support a real Read-While-Write Self-Programming mechanism. There is a separate Boot Loader Section, and the SPM instruction can only execute from there. In ATmega48PA, there is no Read-While-Write support and no separate Boot Loader Section. The SPM instruction can execute from the entire Flash.

3.2. ATmega88PA

Speed [MHz] ⁽³⁾	Power Supply [V]	Ordering Code ⁽²⁾	Package ⁽¹⁾	Operational Range
20	1.8 - 5.5	ATmega88PA-AU	32A	Industrial (-40°C to 85°C)
		ATmega88PA-AUR ⁽⁴⁾	32A	
		ATmega88PA-CCU	32CC1	
		ATmega88PA-CCUR ⁽⁴⁾	32CC1	
		ATmega88PA-MMH ⁽⁵⁾	28M1	
		ATmega88PA-MMHR ⁽⁴⁾⁽⁵⁾	28M1	
		ATmega88PA-MU	32M1-A	
		ATmega88PA-MUR ⁽⁴⁾	32M1-A	
		ATmega88PA-PU	28P3	
		ATmega88PA-AN	32A	Industrial (-40°C to 105°C)
		ATmega88PA-ANR ⁽⁴⁾	32A	
		ATmega88PA-MMN ⁽⁵⁾	28M1	
		ATmega88PA-MMNR ⁽⁴⁾⁽⁵⁾	28M1	
		ATmega88PA-MN	32M1-A	
		ATmega88PA-MNR ⁽⁴⁾	32M1-A	
		ATmega88PA-PN	28P3	

Note:

1. This device can also be supplied in wafer form. Please contact your local Atmel sales office for detailed ordering information and minimum quantities.
2. Pb-free packaging, complies to the European Directive for Restriction of Hazardous Substances (RoHS directive). Also Halide free and fully Green.
3. Please refer to *Speed Grades* for Speed vs. V_{CC}
4. Tape & Reel.
5. NiPdAu Lead Finish.

Package Type	
28M1	28-pad, 4 x 4 x 1.0 body, Lead Pitch 0.45mm Quad Flat No-Lead/Micro Lead Frame Package (QFN/MLF)
28P3	28-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)
32M1-A	32-pad, 5 x 5 x 1.0 body, Lead Pitch 0.50mm Quad Flat No-Lead/Micro Lead Frame Package (QFN/MLF)
32A	32-lead, Thin (1.0mm) Plastic Quad Flat Package (TQFP)
32CC1	32-ball, 4 x 4 x 0.6mm package, ball pitch 0.5mm, Ultra Thin, Fine-Pitch Ball Grill Array (UFBGA)

3.3. ATmega168PA

Speed [MHz] ⁽³⁾	Power Supply [V]	Ordering Code ⁽²⁾	Package ⁽¹⁾	Operational Range
20	1.8 - 5.5	ATmega168PA-AU	32A	Industrial (-40°C to 85°C)
		ATmega168PA-AUR ⁽⁵⁾	32A	
		ATmega168PA-CCU	32CC1	
		ATmega168PA-CCUR ⁽⁵⁾	32CC1	
		ATmega168PA-MMH ⁽⁴⁾	28M1	
		ATmega168PA-MMHR ⁽⁴⁾⁽⁵⁾	28M1	
		ATmega168PA-MU	32M1-A	
		ATmega168PA-MUR ⁽⁵⁾	32M1-A	
		ATmega168PA-PU	28P3	
		ATmega168PA-AN	32A	Industrial (-40°C to 105°C)
		ATmega168PA-ANR ⁽⁵⁾	32A	
		ATmega168PA-MN	32M1-A	
		ATmega168PA-MNR ⁽⁵⁾	32M1-A	
		ATmega168PA-PN	28P3	

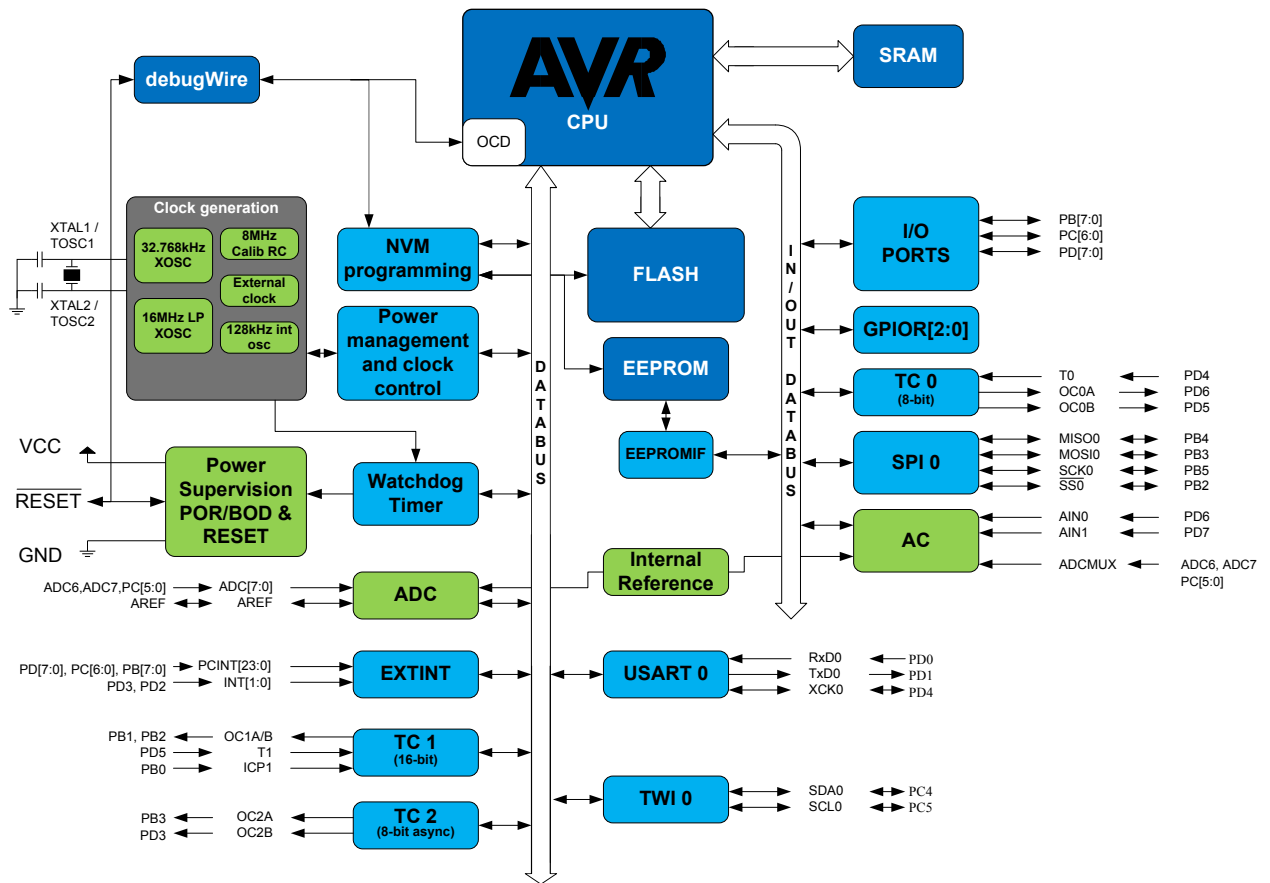
Note:

1. This device can also be supplied in wafer form. Please contact your local Atmel sales office for detailed ordering information and minimum quantities.
2. Pb-free packaging, complies to the European Directive for Restriction of Hazardous Substances (RoHS directive). Also Halide free and fully Green.
3. Please refer to *Speed Grades* for Speed vs. V_{CC}
4. Tape & Reel.
5. NiPdAu Lead Finish.

Package Type	
28M1	28-pad, 4 x 4 x 1.0 body, Lead Pitch 0.45mm Quad Flat No-Lead/Micro Lead Frame Package (QFN/MLF)
28P3	28-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)
32M1-A	32-pad, 5 x 5 x 1.0 body, Lead Pitch 0.50mm Quad Flat No-Lead/Micro Lead Frame Package (QFN/MLF)
32A	32-lead, Thin (1.0mm) Plastic Quad Flat Package (TQFP)
32CC1	32-ball, 4 x 4 x 0.6mm package, ball pitch 0.5mm, Ultra Thin, Fine-Pitch Ball Grill Array (UFBGA)

4. Block Diagram

Figure 4-1. Block Diagram



5. Pin Configurations

5.1. Pin-out

Figure 5-1. 28-pin PDIP

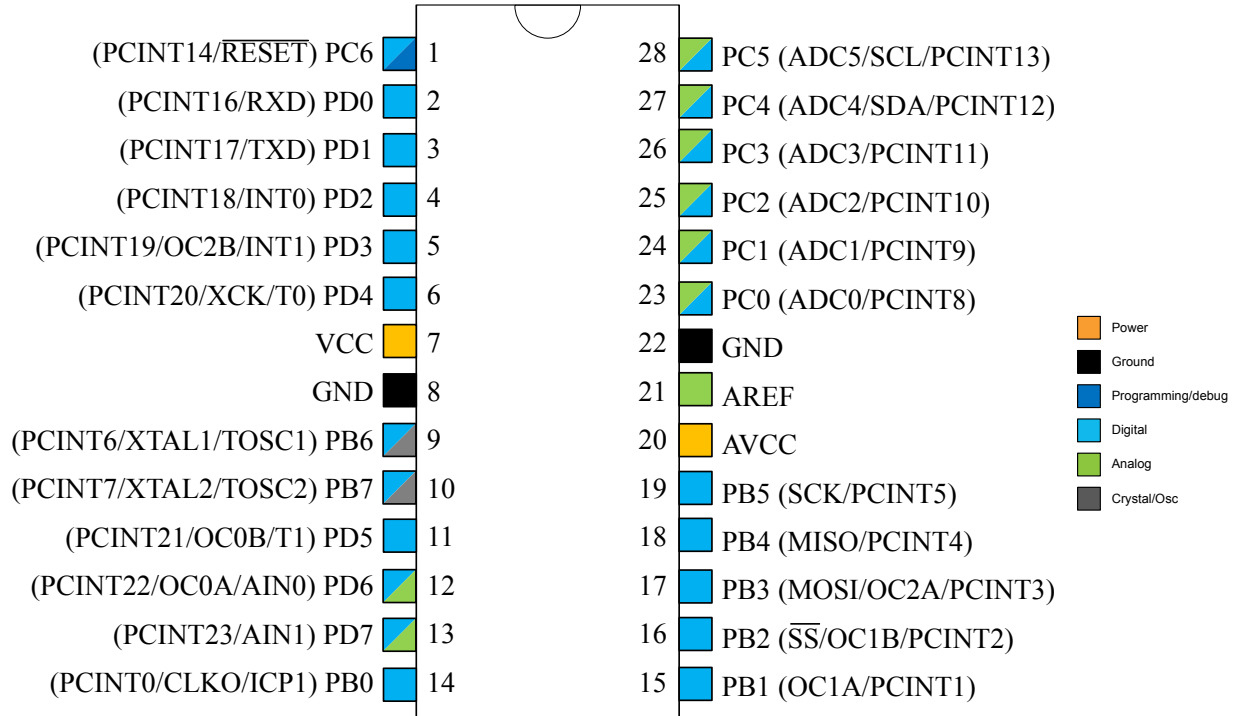


Figure 5-2. 28-pin MLF Top View

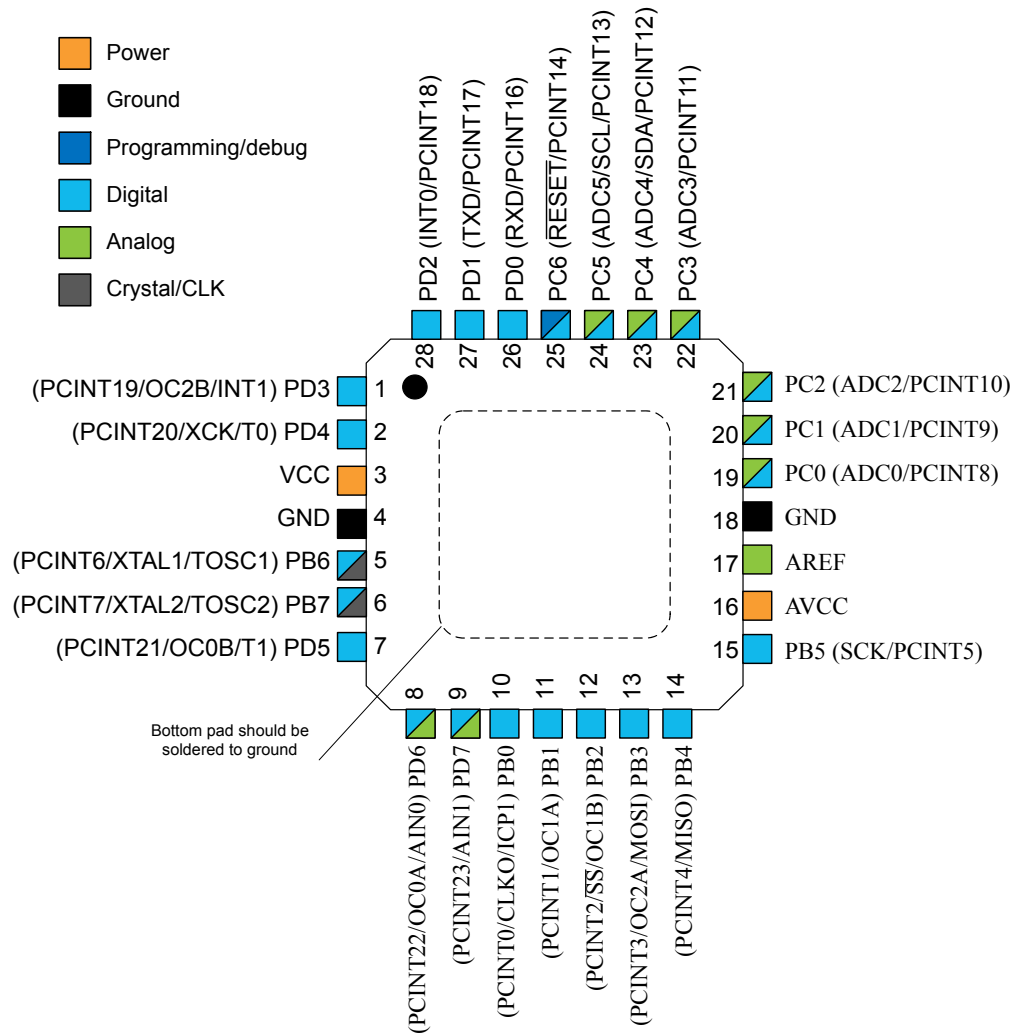


Figure 5-3. 32-pin TQFP Top View

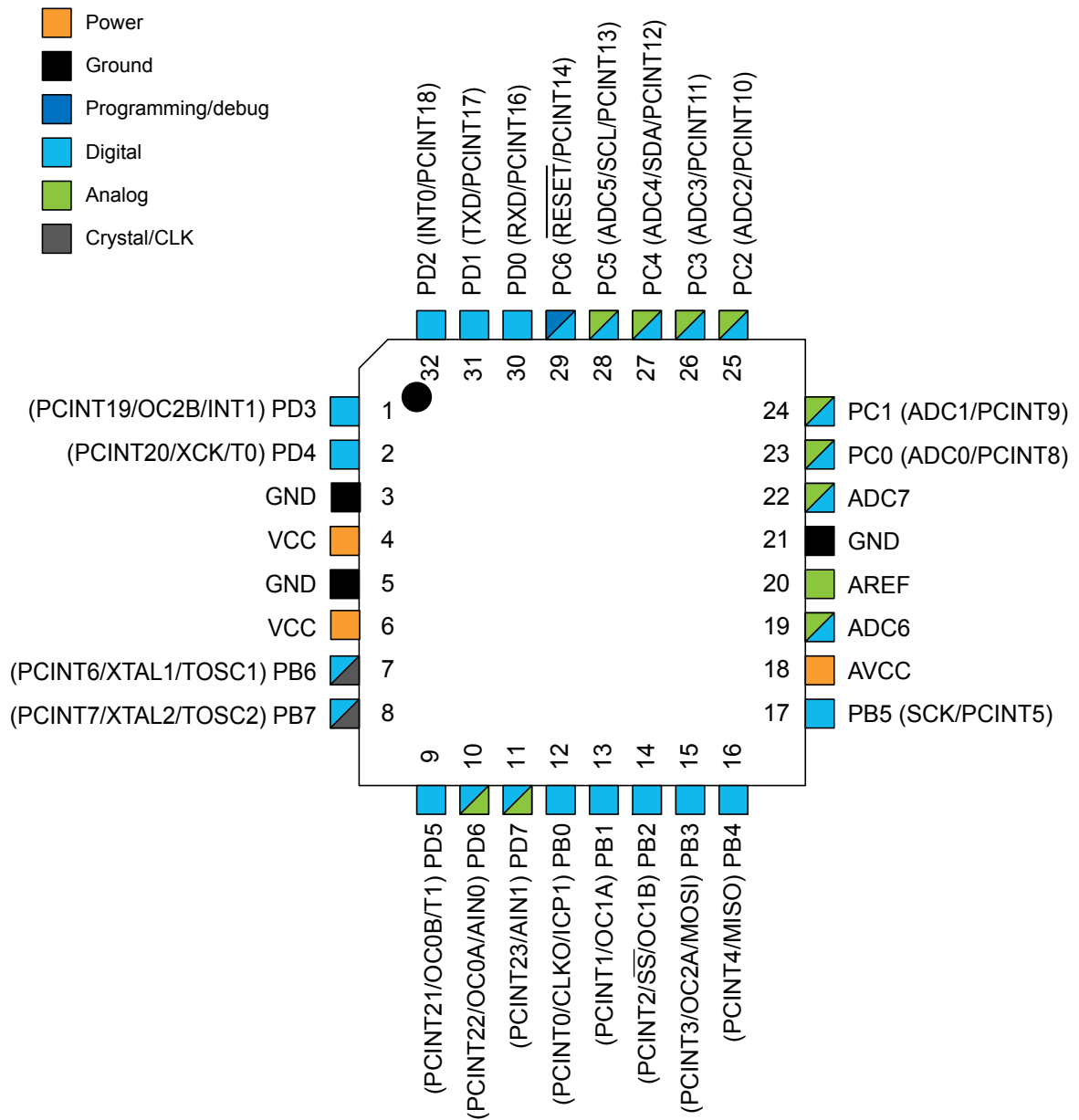


Figure 5-4. 32-pin MLF Top View

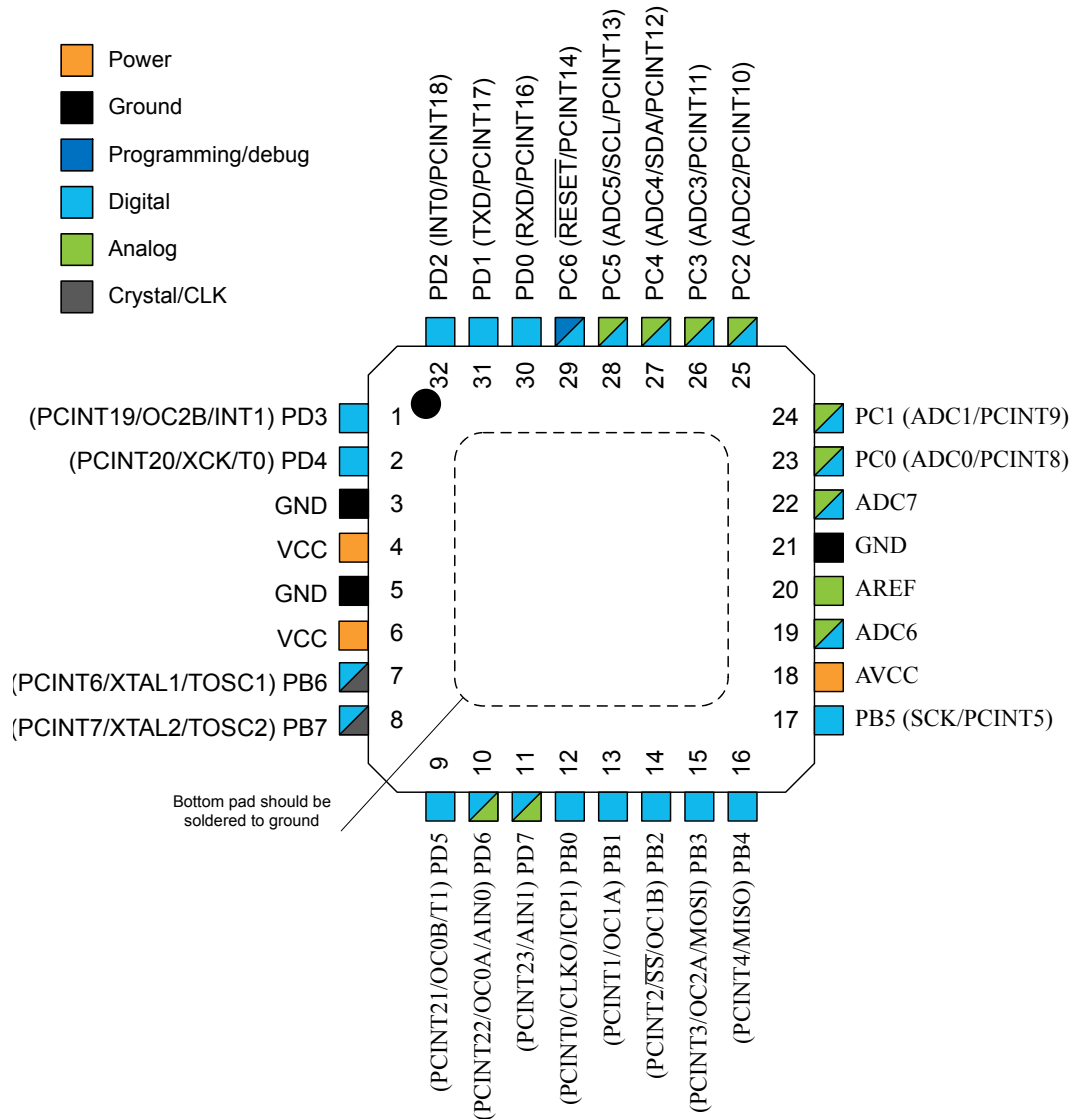


Table 5-1. 32UFBGA

	1	2	3	4	5	6
A	PD2	PD1	PC6	PC4	PC2	PC1
B	PD3	PD4	PD0	PC5	PC3	PC0
C	GND	GND	-	-	ADC7	GND
D	VCC	VCC	-	-	AREF	ADC6
E	PB6	PD6	PB0	PB2	AVCC	PB5
F	PB7	PD5	PD7	PB1	PB3	PB4

5.2. Pin Descriptions

5.2.1. VCC

Digital supply voltage.

5.2.2. GND

Ground.

5.2.3. Port B (PB[7:0]) XTAL1/XTAL2/TOSC1/TOSC2

Port B is an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port B output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port B pins that are externally pulled low will source current if the pull-up resistors are activated. The Port B pins are tri-stated when a reset condition becomes active, even if the clock is not running.

Depending on the clock selection fuse settings, PB6 can be used as input to the inverting Oscillator amplifier and input to the internal clock operating circuit.

Depending on the clock selection fuse settings, PB7 can be used as output from the inverting Oscillator amplifier.

If the Internal Calibrated RC Oscillator is used as chip clock source, PB[7:6] is used as TOSC[2:1] input for the Asynchronous Timer/Counter2 if the AS2 bit in ASSR is set.

5.2.4. Port C (PC[5:0])

Port C is a 7-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The PC[5:0] output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port C pins that are externally pulled low will source current if the pull-up resistors are activated. The Port C pins are tri-stated when a reset condition becomes active, even if the clock is not running.

5.2.5. PC6/RESET

If the RSTDISBL Fuse is programmed, PC6 is used as an I/O pin. Note that the electrical characteristics of PC6 differ from those of the other pins of Port C.

If the RSTDISBL Fuse is unprogrammed, PC6 is used as a Reset input. A low level on this pin for longer than the minimum pulse length will generate a Reset, even if the clock is not running. Shorter pulses are not guaranteed to generate a Reset.

The various special features of Port C are elaborated in the *Alternate Functions of Port C* section.

5.2.6. Port D (PD[7:0])

Port D is an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port D output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port D pins that are externally pulled low will source current if the pull-up resistors are activated. The Port D pins are tri-stated when a reset condition becomes active, even if the clock is not running.

5.2.7. AV_{CC}

AV_{CC} is the supply voltage pin for the A/D Converter, PC[3:0], and PE[3:2]. It should be externally connected to V_{CC}, even if the ADC is not used. If the ADC is used, it should be connected to V_{CC} through a low-pass filter. Note that PC[6:4] use digital supply voltage, V_{CC}.

5.2.8. AREF

AREF is the analog reference pin for the A/D Converter.

5.2.9. ADC[7:6] (TQFP and VFQFN Package Only)

In the TQFP and VFQFN package, ADC[7:6] serve as analog inputs to the A/D converter. These pins are powered from the analog supply and serve as 10-bit ADC channels.

(32-pin 32UFBGA) Pin#	(32-pin MLF/ TQFP) Pin#	(28-pin MLF) Pin#	(28-pin PIPD) Pin#	PAD	EXTINT	PCINT	ADC/A C	OSC	T/C #0	T/C #1	USART 0	I2C 0	SPI 0
A3	29	25	1	PC[6]/ RESET		PCINT14							
B3	30	26	2	PD[0]		PCINT16					RXD0		
A2	31	27	3	PD[1]		PCINT17					TXD0		
A1	32	28	4	PD[2]	INT0	PCINT18							

7. Resources

A comprehensive set of development tools, application notes, and datasheets are available for download on <http://www.atmel.com/avr>.

8. Data Retention

Reliability Qualification results show that the projected data retention failure rate is much less than 1 PPM over 20 years at 85°C.

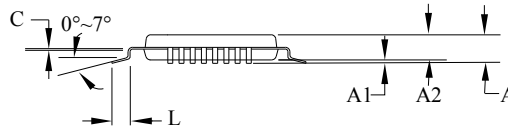
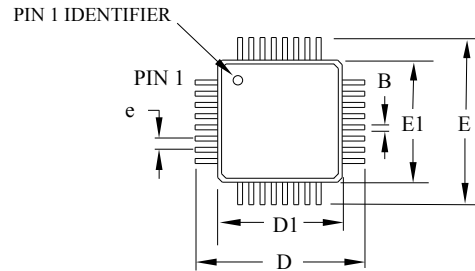
9. About Code Examples

This documentation contains simple code examples that briefly show how to use various parts of the device. These code examples assume that the part specific header file is included before compilation. Be aware that not all C compiler vendors include bit definitions in the header files and interrupt handling in C is compiler dependent. Confirm with the C compiler documentation for more details.

For I/O Registers located in extended I/O map, “IN”, “OUT”, “SBIS”, “SBIC”, “CBI”, and “SBI” instructions must be replaced with instructions that allow access to extended I/O. Typically “LDS” and “STS” combined with “SBR”, “SBRC”, “SBR”, and “CBR”.

11. Packaging Information

11.1. 32-pin 32A



COMMON DIMENSIONS
(Unit of measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	—	—	1.20	
A1	0.05	—	0.15	
A2	0.95	1.00	1.05	
D	8.75	9.00	9.25	
D1	6.90	7.00	7.10	Note 2
E	8.75	9.00	9.25	
E1	6.90	7.00	7.10	Note 2
B	0.30	—	0.45	
C	0.09	—	0.20	
L	0.45	—	0.75	
e	0.80 TYP			

Notes:

1. This package conforms to JEDEC reference MS-026, Variation ABA.
2. Dimensions D1 and E1 do not include mold protrusion. Allowable protrusion is 0.25mm per side. Dimensions D1 and E1 are maximum plastic body size dimensions including mold mismatch.
3. Lead coplanarity is 0.10mm maximum.

2010-10-20

Atmel

TITLE

**32A, 32-lead, 7 x 7mm body size, 1.0mm body thickness,
0.8mm lead pitch, thin profile plastic quad flat package (TQFP)**

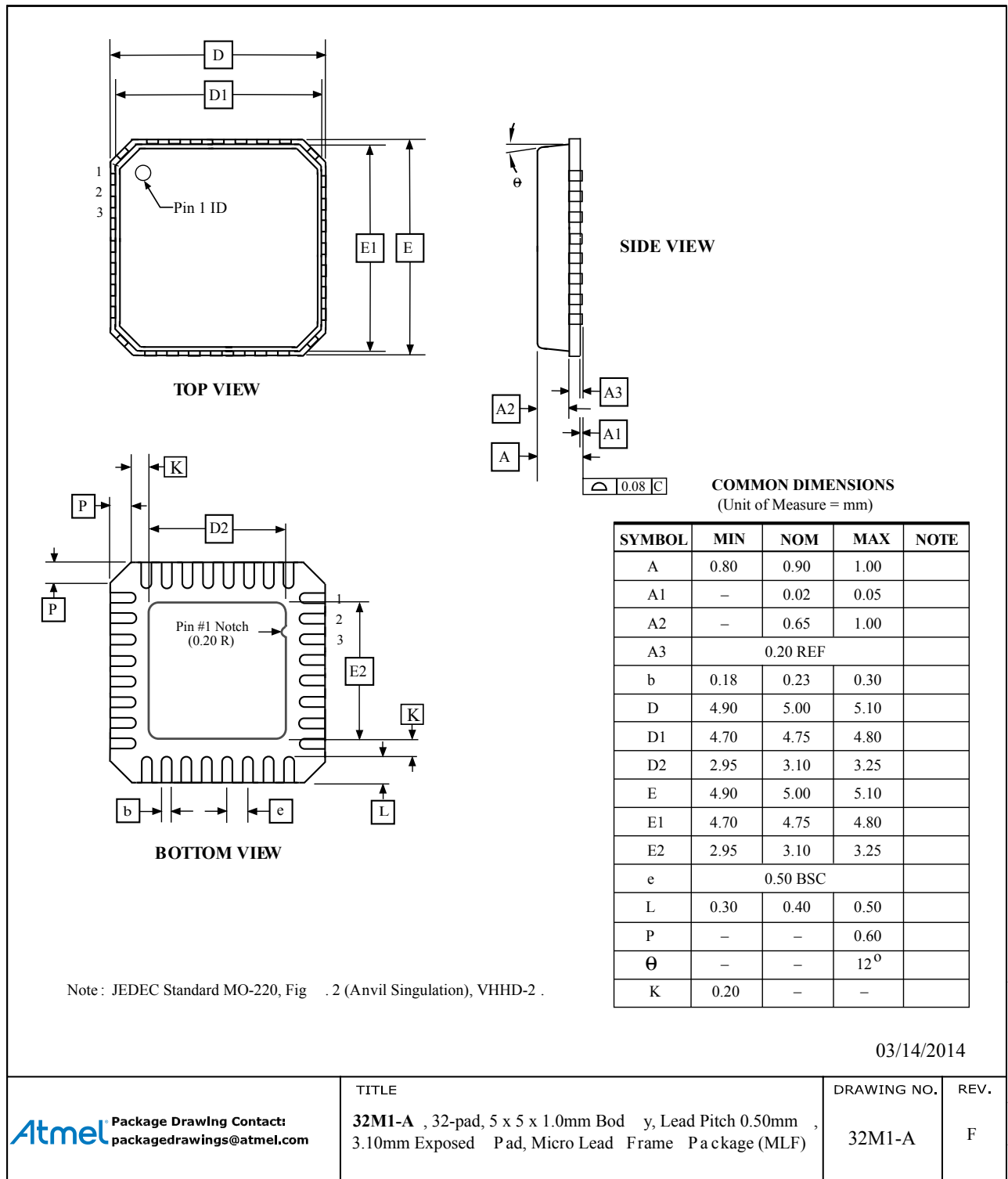
DRAWING NO.

32A

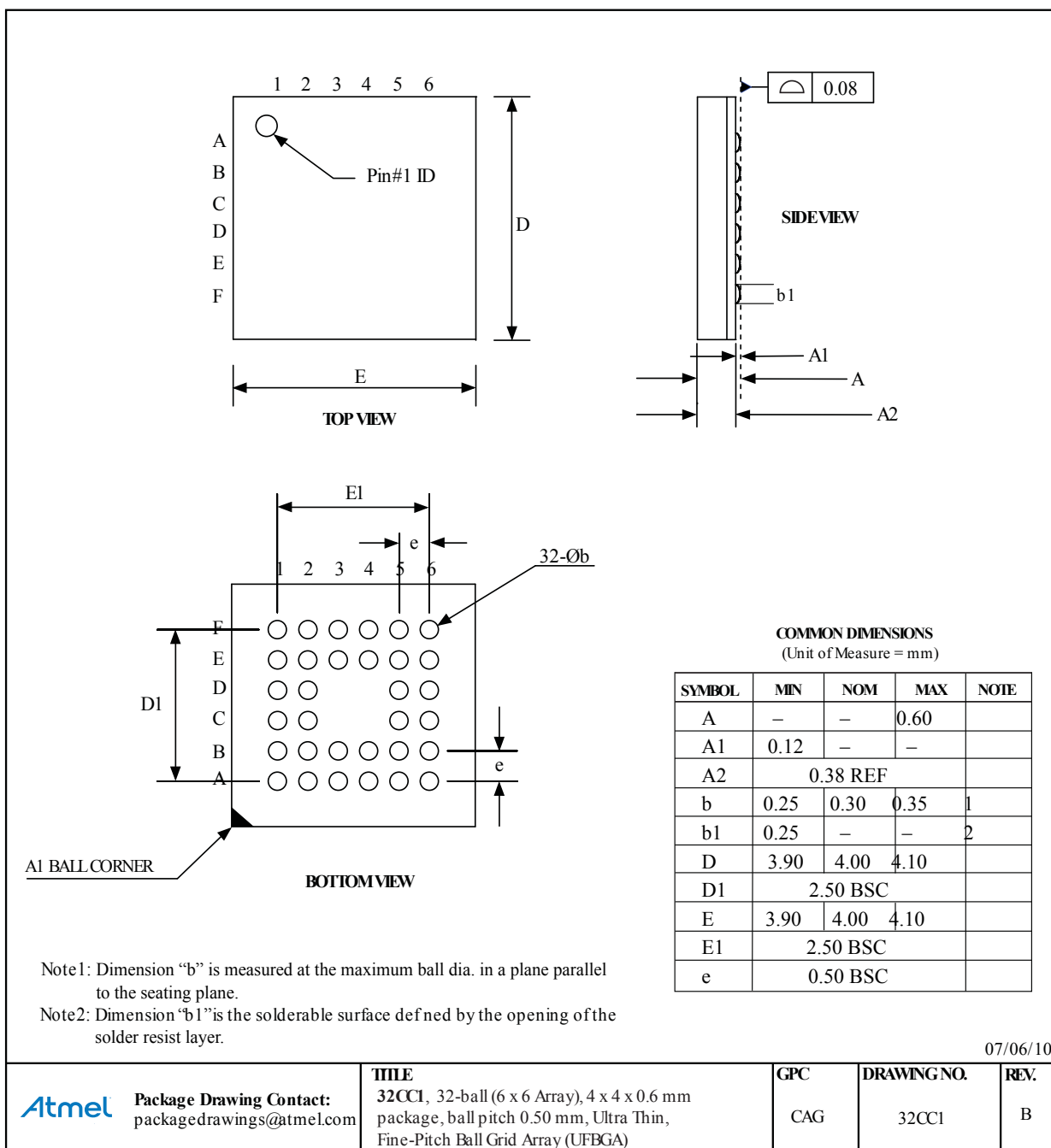
REV.

C

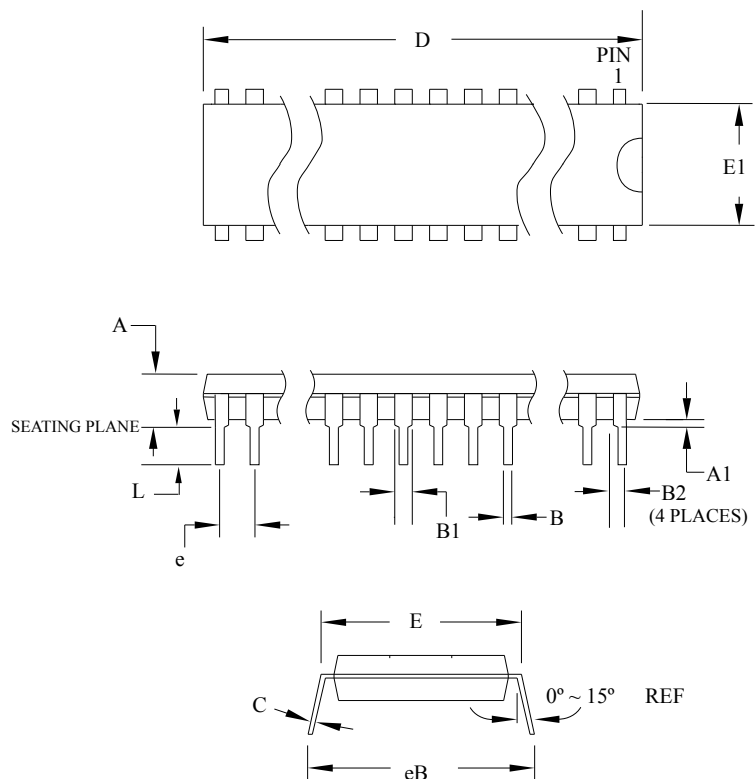
11.2. 32-pin 32M1-A



11.3. 32-pin 32CC1



11.5. 28-pin 28P3



Note: 1. Dimensions D and E1 do not include mold Flash or Protrusion.
Mold Flash or Protrusion shall not exceed 0.25mm (0.010").

COMMON DIMENSIONS
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	—	—	4.5724	
A1	0.508	—	—	
D	34.544	—	34.798	Note 1
E	7.620	—	8.255	
E1	7.112	—	7.493	Note 1
B	0.381	—	0.533	
B1	1.143	—	1.397	
B2	0.762	—	1.143	
L	3.175	—	3.429	
C	0.203	—	0.356	
eB	—	—	10.160	
e	2.540 TYP			

09/28/01

Atmel 2325 Orchard Parkway
San Jose, CA 95131

TITLE
28P3, 28-lead (0.300"/7.62mm Wide) Plastic Dual
Inline Package (PDIP)

DRAWING NO.
28P3

REV.
B